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RENESAS SEMICONDUCTOR RELIABILITY REPORT

- GROUP : RL78/L1C
- DEVICE : R5F110XXX
- APPLICATION : Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



MCR-22-0611

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Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 ℃ to 150 ℃ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	00 pF, +/-2000 V, 1 time 0/3	
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	me 0/3	
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .



Table. Reliability test results (LGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^\circ$ to 125 $^\circ$, 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat JESD22-A1: (PC) J-STD-02		MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .



The failure rate of the device in an actual use condition can be estimated by the below procedure.

• Equation for the failure rate estimation (λ)

 $\lambda = \lambda b \times \pi T$ (FIT)

(1) Unique failure rate (λb)

λb= 3.8 FIT

Unique failure rate at Ta=55 $^{\circ}$ C using 60 $^{\circ}$ confidence level.

②Temperature term (π T)

 π T=exp{11600×Ea×(1/(273+55)-1/(273+Ta))}

Ea: Activation energy (eV)

Ta : Ambient temperature ($^{\circ}$ C)

π	π T simplified chart as Ea=0.7 eV												
	Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
;	πΤ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

•MTTF (Mean Time To Failure)

 $MTTF = 1/\lambda$



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Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

*1. First four digit

Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RL78/L1C	R5F110MEAFB	PLQP0080K*	51	Group		
2	RL78/L1C	R5F110MEGFB	PLQP0080K*	52			
3	RL78/L1C	R5F110MFAFB	PLQP0080K*	52			
4	RL78/L1C	R5F110MFGFB	PLQP0080K*	55			
5	RL78/L1C	R5F110MGAFB	PLQP0080K*	55			
6	RL78/L1C	R5F110MGGFB	PLQP0080K*	56			
7	RL78/L1C	R5F110MHAFB	PLQP0080K*	57			
8	RL78/L1C	R5F110MHGFB	PLQP0080K*	58			
9	RL78/L1C	R5F110MJAFB	PLQP0080K*	59			
10	RL78/L1C	R5F110MJGFB	PLQP0080K*	60			
11	RL78/L1C	R5F110NEALA	PVLG0085J*	61			
12	RL78/L1C	R5F110NEGLA	PVLG0085J*	62			
13	RL78/L1C	R5F110NFALA	PVLG0085J*	63			
14	RL78/L1C	R5F110NFGLA	PVLG0085J*	64			
15	RL78/L1C	R5F110NGALA	PVLG0085J*	65			
16	RL78/L1C	R5F110NGGLA	PVLG0085J*	66	1		
17	RL78/L1C	R5F110NHALA	PVLG0085J*	67	1		
17	RL78/L1C	R5F110NHGLA	PVLG0085J*	68	1		
19	RL78/L1C	R5F110NJALA	PTLG0085J*	69	1		
20	RL78/L1C	R5F110NJGLA	PVLG0085J*	70			
20	RL78/L1C	R5F110PEAFB	PLQP0100K*	70			
22	RL78/L1C	R5F110PEGFB	PLQP0100K*	72			
23	RL78/L1C	R5F110PFAFB	PLQP0100K*	73			
24	RL78/L1C	R5F110PFGFB	PLQP0100K*	74			
25	RL78/L1C	R5F110PGAFB	PLQP0100K*	75			
26	RL78/L1C	R5F110PGGFB	PLQP0100K*	76			
27	RL78/L1C	R5F110PHAFB	PLQP0100K*	77			
28	RL78/L1C	R5F110PHGFB	PLQP0100K*	78			
29	RL78/L1C	R5F110PJAFB	PLQP0100K*	70			
30	RL78/L1C	R5F110PJGFB	PLQP0100K*	80			
31	INE/ 0/ LIC			81			
32				82			
33				83			
34				84			
35				85			
36				86			
37				87			
38	1		1	88	1		1
39	1		1	89	1		
40	1		1	90	1		
41	1		1	91	1		1
42	1		1	92	1		1
43	1		1	93	1		
44	1		1	94	1		
45	1		1	95	1		
46	1		1	96	1		
47	1		1	97	1		
48	1	1	1	98	1		1
49	1		1	99	1		1
50	1		1	100	1		1